Gender: Female

+86-13679113307

Age: 24 (13/12/1999)

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ACADEMIC QUALIFICATIONS

Northwestern Polytechnical University, China

M.S. Flexible Electronics | GPA: 3.77/4 (Top 5%)

Exam-exempted postgraduate | Supervisor: Prof. Xuewen Wang

Agency for Science, Technology and Research, Singapore

Institute of Materials Research and Engineering | Supervisor: Prof. Xian Jun Loh

China Scholarship Council (CSC) Joint Master's Degree Program

Xi'an University of Technology, China

B.S. Printing Engineering | GPA: 4.51/5 (Rank: 1/123)

RESEARCH EXPERIENCE

Flexible Polyimide Field-effect Transistors Based on 2D/1D Semiconductor Materials

- Synthesized tellurium (Te) nanoribbons by Chemical Vapor Deposition (CVD)
- Raman, XPS, AFM, SEM, TEM, etc. for characterizations of Te nanoribbons
- Fabrication of tellurium nanoribbons-based field-effect transistors by Electron beam lithography (EBL) or Photolithography
- Investigated the photoelectric properties of field-effect transistors, such as carrier mobility and optical effect characteristics at room and low temperature

2D/1D Semiconductor Materials with Piezoelectric/Ferroelectric Properties

- Measurement of piezoelectric/ferroelectric response of materials by piezoelectric force microscopy (PFM), second harmonic (SHG).
- Development of improved nanoscale sensors, transducers, and storage devices using piezoelectric and ferroelectric properties

Design and Regulation Method of Large Area Flexible Polyimide Substrate

- Synthesized polyamide-acid solution (PAA) by poly-condensation
- Prepared polyimide films by programmed heat treatment
- AFM, SEM, XRD, mechanical characterizations of polyimide films

Photosensitive Flexible Polyimide Shadow Masks Based on Photolithography

- Preparation of photosensitive polyimide film shadow masks by photolithography
- Various characterization and improvement of the flexible shadow masks
- Preparation of curved electrodes using shadow masks and other applications



09/2021-Present

09/2022-10/2023

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09/2017-07/2021

RESEARCH ACHIEVEMENTS

Journals:

[1] **Xuan Dong**, Xuewen Wang, et al. Implementation of High-Performance, Free-standing Flexible Film Masks through Photosensitive Polyimide for Arbitrary Surface Micropatterns Creation. (2023, Reviewed by *Small*)

[2] **Xuan Dong**, Xuewen Wang, et al. Exploring Photosensitive Polyimides in Flexible Electronics Review. (2023, Under Review by *ChemComm*)

[3] Ruoqing Zhao, **Xuan Dong**, et al. Enhancing the Toughness of Free-Standing Polyimide Films for Advanced Electronics Applications: A Study on the Impact of Film-Forming Processes. *Polymers*, 2023, 15(9): 2073. (SCI | Published)

[4] **Xuan Dong**, Xuewen Wang, et al. Tellurium Nanoribbon-Based Polyimide Substrates for Flexible Ambipolar Field-Effect Transistors. (In preparation)

[5] **Xuan Dong**, Xuewen Wang, et al. Flexible nanogenerators based on single tellurium nanoribbon (in preparation)

[6] Leiluo, **Xuan Dong**, et al. Ultra-low Power Consumption Flexible Sensing Electronics by Dendritic Bilayer MoS₂. (2023, Under Review by *Advanced Materials*)

Patents:

[1] Xuewen Wang, **Xuan Dong**, et al. "A film shadow mask prepared by photolithography and its application", China Invention Patent, Application Number 202211069751. X

[2] Xuewen Wang, **Xuan Dong**, et al. "An ultra-thin polyimide film thickness measurement method", China Invention Patent, Application Number 202211065917.0

PROJECT PRACTICE

[1] Xuewen Wang (PI), **Xuan Dong**, et al., Design and control method of large area flexible substrate. National Key Research & Development Program (2020YFB2008501)

[2] Manzhang Xu (PI), **Xuan Dong**, et al., The Natural Science Foundation of Shaanxi Province (2022JQ-659)

PERSONAL SKILLS

Languages: English (CET6 / IELTS), Mandarin (native)

Characterization Techniques: Proficiency in operation and data processing of Transmission electron microscopy (TEM), Scanning electron microscope (SEM), Atomic force microscope (AFM), Raman, and X-ray photoelectron spectroscopy (XPS).

Equipment Operations: Proficiency in Laser direct writing, Mask aligner, Magnetron sputtering, Electron-beam evaporation, Thermal evaporation, Atomic layer deposition (ALD), Oxygen plasma treatment, Ultrasonic cleaning machine, Ultrasonic cell crusher, Vacuum drying oven, Spin coater,

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Optical microscope.

Computer Software: Proficiency in Origin, Microsoft Office, Photoshop, Illustrator, Indesign, AutoCAD, 3d Max, Endnotes.

MAIN AWARDS	
National level	
 "The Challenge Cup", First Prize in the National Finals 	2023
 CSC National Public Scholarship for Study Abroad 	2022
China National Scholarship	2020
 First Prize in Mathematics Competition of Chinese College Students 	2019
Provincial level	
 Shaanxi Province Excellent Graduates 	2021
 First Prize in the Shaanxi Advanced Mathematics Competition 	2020
Social level	
 Jetta Company Limited First-Class Academic Scholarship 	2019
 Dongfeng Printing Company Second-Class Academic Scholarship 	2018
School level	
 Second-class scholarship, Northwestern Polytechnical University 	2022
 First-class scholarship, Northwestern Polytechnical University 	2021
REFEREES	

[1] Prof. Wei Huang

Academician of Chinese Academy of Sciences Institute of Flexible Electronics, Northwestern Polytechnical University Research webpage: http://teacher.nwpu.edu.cn/en/huangwei

[2] Prof. Xian Jun Loh

PhD, FRSC, FIMMM, FIET, FSNIC

Institute of Materials Research and Engineering (IMRE), Singapore

Research webpage: https://www.a-star.edu.sg/imre/home

[3] Prof. Xuewen Wang

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